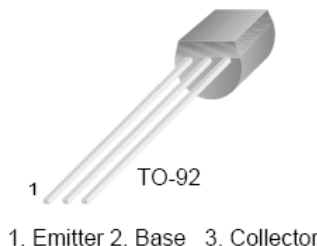


MPSA20

NPN General Purpose Amplifier

Features

- BV_{CEO} 40V(Min)
- h_{FE} 40~400 @ $V_{CE}=10V$, $I_C=5mA$
- Pb free
- Sourced from process 10



Absolute Maximum Ratings $T_a = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Unit
V_{CEO}	Collector-Emitter Voltage	40	V
V_{EBO}	Emitter-Base Voltage	4	V
I_C	Collector Current	100	mA
T_J	Junction Temperature	150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 ~ 150	$^\circ\text{C}$

* 1. These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

Thermal Characteristics* $T_a=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Max	Unit
P_C	Collector Power Dissipation, by $R_{\theta JA}$	625	mW
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	$^\circ\text{C}/\text{W}$

* 2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

3. These ratings are based on a maximum junction temperature of 150 degrees C.

4. Device mounted on FR-4 PCB 36mm * 1.5mm: Mounting pad for the collector lead min.6cm.

Electrical Characteristics* $T_a=25^\circ\text{C}$ unless otherwise noted


Symbol	Parameter	Test Condition	Min.	Max.	Unit
BV_{CEO}	Collector-Emitter Breakdown Voltage	$I_C = 1mA$, $I_B = 0$	40		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = 100\mu A$, $I_C = 0$	4		V
I_{CBO}	Collector Cut-off Current	$V_{CB} = 30V$		100	nA
h_{FE}	DC Current Gain	$V_{CE} = 10V$, $I_C = 5mA$	40	400	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = 10mA$, $I_B = 1mA$		0.25	V
$V_{BE(on)}$	Base-Emitter On Voltage	$V_{CE} = -10V$, $I_C = -10mA$	-0.5	-1.2	V
C_{cb}	Output Capacitance	$V_{CB} = 10V$, $f = 100kHz$		4.0	pF
f_T	Current Gain Bandwidth Product	$V_{CE} = 10V$, $I_C = 5mA$, $f = 100MHz$	125		Mhz

* DC Item are tested by Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$



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